

FS50KM-2

HIGH-SPEED SWITCHING USE

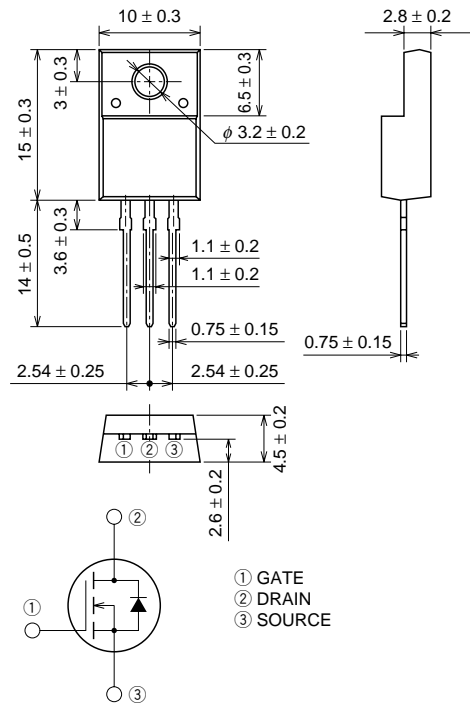
FS50KM-2



- 10V DRIVE
- $V_{DS}$  ..... 100V
- $r_{DS(ON)}(MAX)$  .....  $55m\Omega$
- $I_D$  ..... 50A
- Integrated Fast Recovery Diode (TYP.) ..... 105ns
- $V_{iso}$  ..... 2000V

OUTLINE DRAWING

Dimensions in mm



TO-220FN

APPLICATION

Motor control, Lamp control, Solenoid control  
DC-DC converter, etc.

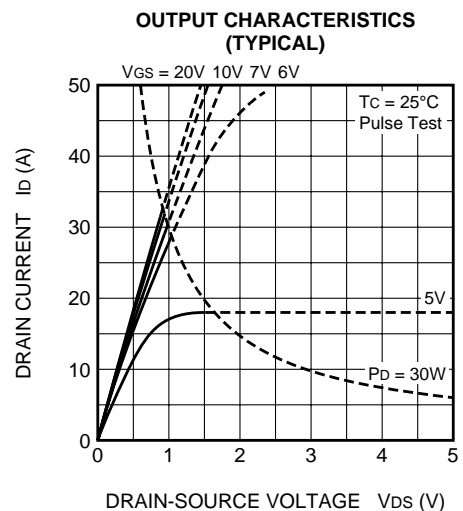
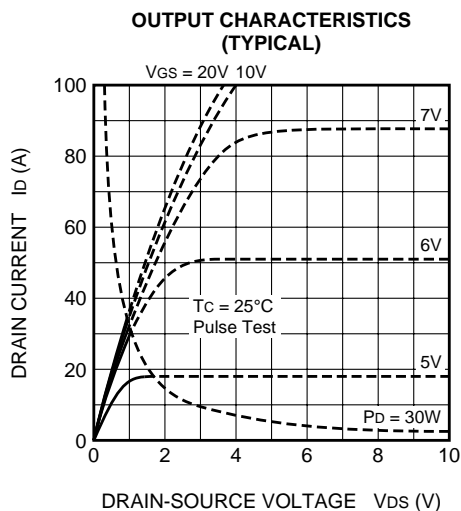
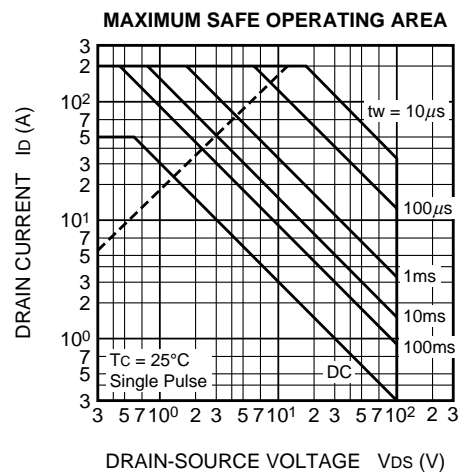
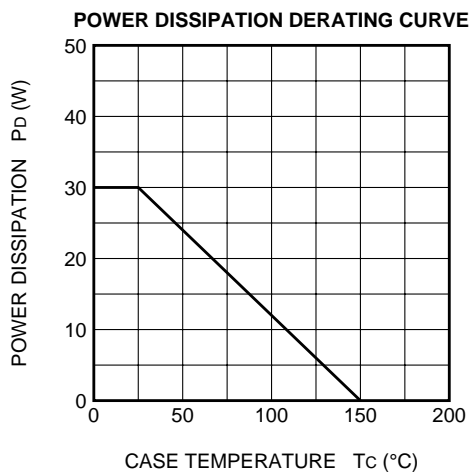
MAXIMUM RATINGS (Tc = 25°C)

Symbol	Parameter	Conditions	Ratings	Unit
$V_{DS}$	Drain-source voltage	$V_{GS} = 0V$	100	V
$V_{GSS}$	Gate-source voltage	$V_{DS} = 0V$	$\pm 20$	V
$I_D$	Drain current		50	A
$I_{DM}$	Drain current (Pulsed)		200	A
$I_{DA}$	Avalanche drain current (Pulsed)	$L = 50\mu H$	50	A
$I_S$	Source current		50	A
$I_{SM}$	Source current (Pulsed)		200	A
$P_D$	Maximum power dissipation		30	W
$T_{ch}$	Channel temperature		$-55 \sim +150$	°C
$T_{stg}$	Storage temperature		$-55 \sim +150$	°C
$V_{iso}$	Isolation voltage	AC for 1minute, Terminal to case	2000	V
—	Weight	Typical value	2.0	g

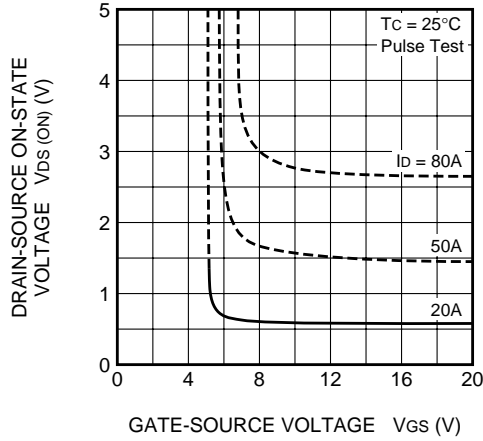
ELECTRICAL CHARACTERISTICS (Tch = 25°C)

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
V(BR)DSS	Drain-source breakdown voltage	Id = 1mA, VGS = 0V	100	—	—	V
IGSS	Gate-source leakage current	VGS = ±20V, VDS = 0V	—	—	±0.1	μA
IDSS	Drain-source leakage current	VDS = 100V, VGS = 0V	—	—	0.1	mA
VGS(th)	Gate-source threshold voltage	Id = 1mA, VDS = 10V	2.0	3.0	4.0	V
rDS(ON)	Drain-source on-state resistance	Id = 25A, VGS = 10V	—	39	55	mΩ
VDS(ON)	Drain-source on-state voltage	Id = 25A, VGS = 10V	—	0.98	1.38	V
yfs	Forward transfer admittance	Id = 25A, VDS = 10V	—	33	—	S
Ciss	Input capacitance	VDS = 10V, VGS = 0V, f = 1MHz	—	2300	—	pF
Coss	Output capacitance		—	410	—	pF
Crss	Reverse transfer capacitance		—	185	—	pF
td(on)	Turn-on delay time	VDD = 50V, Id = 25A, VGS = 10V, RGEN = RGS = 50Ω	—	35	—	ns
tr	Rise time		—	86	—	ns
td(off)	Turn-off delay time		—	100	—	ns
tf	Fall time		—	80	—	ns
VSD	Source-drain voltage	Is = 25A, VGS = 0V	—	1.0	1.5	V
Rth(ch-c)	Thermal resistance	Channel to case	—	—	4.17	°C/W
trr	Reverse recovery time	Is = 50A, dis/dt = -100A/μs	—	105	—	ns

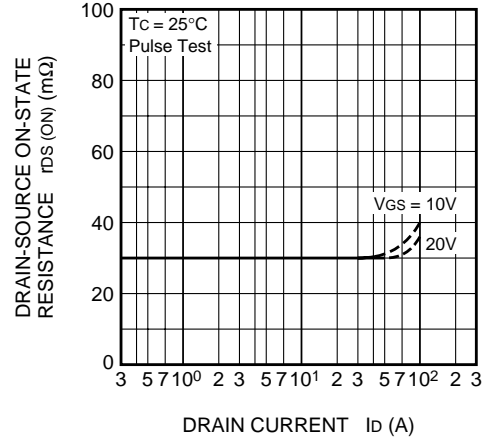
PERFORMANCE CURVES



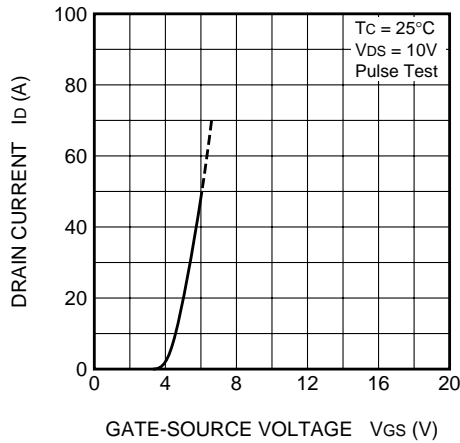
ON-STATE VOLTAGE VS.  
GATE-SOURCE VOLTAGE  
(TYPICAL)



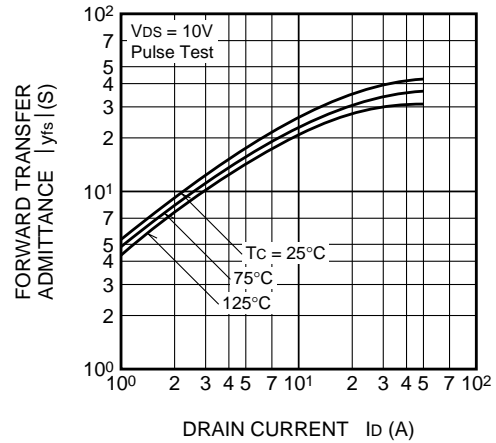
ON-STATE RESISTANCE VS.  
DRAIN CURRENT  
(TYPICAL)



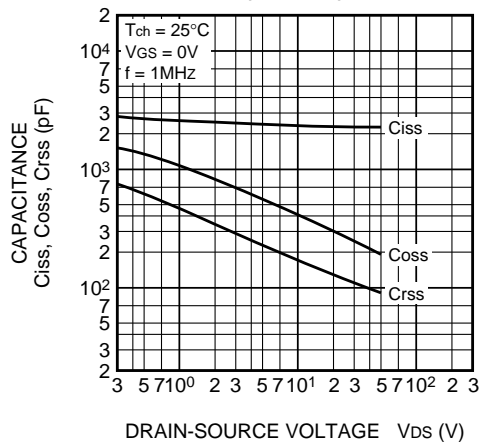
TRANSFER CHARACTERISTICS  
(TYPICAL)



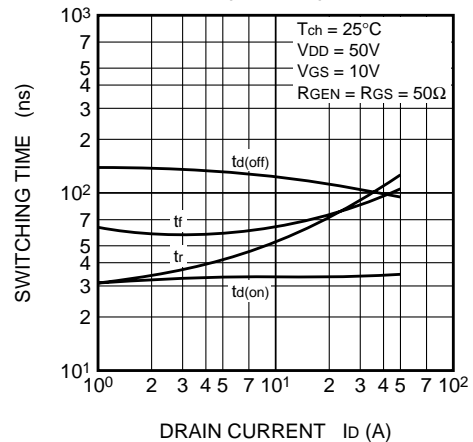
FORWARD TRANSFER ADMITTANCE  
VS. DRAIN CURRENT  
(TYPICAL)



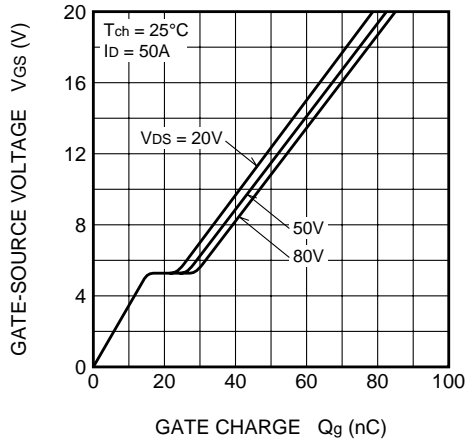
CAPACITANCE VS.  
DRAIN-SOURCE VOLTAGE  
(TYPICAL)



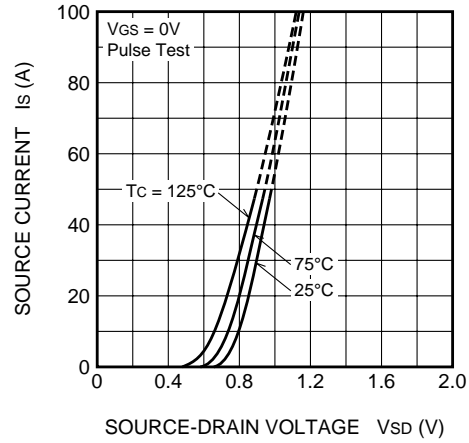
SWITCHING CHARACTERISTICS  
(TYPICAL)



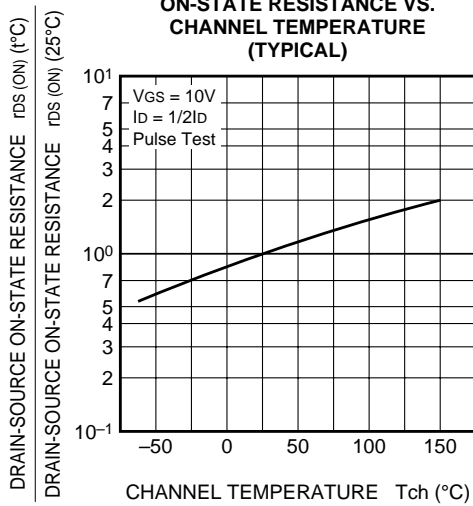
GATE-SOURCE VOLTAGE  
VS. GATE CHARGE  
(TYPICAL)



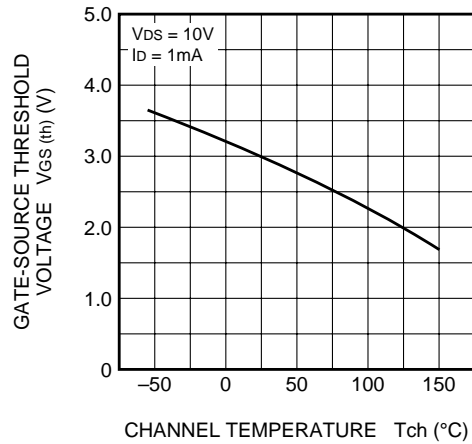
SOURCE-DRAIN DIODE  
FORWARD CHARACTERISTICS  
(TYPICAL)



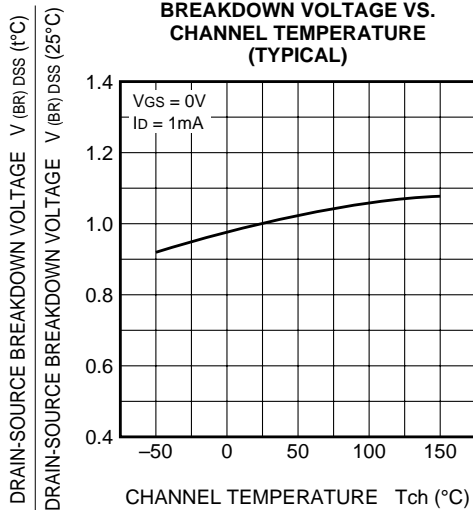
ON-STATE RESISTANCE VS.  
CHANNEL TEMPERATURE  
(TYPICAL)



THRESHOLD VOLTAGE VS.  
CHANNEL TEMPERATURE  
(TYPICAL)



BREAKDOWN VOLTAGE VS.  
CHANNEL TEMPERATURE  
(TYPICAL)



TRANSIENT THERMAL IMPEDANCE  
CHARACTERISTICS

